

SN74GTL16615

17-BIT GTL/LVT UNIVERSAL BUS TRANSCEIVER WITH BUFFERED CLOCK OUTPUTS

SCBS269 – MARCH 1993 – REVISED MARCH 1994

- Translates Between GTL Signal Levels and LVCMOS, LVTTL, or 5-V TTL Signal Levels
- Member of the Texas Instruments *Widebus™* Family
- Supports Mixed-Mode Signal Operation on A Port (5-V Input and Output Voltages With 3.3-V V_{CC})
- State-of-the-Art BiCMOS Design for Low-Static Power Dissipation
- *UBT™* (Universal Bus Transceiver) Combines D-Type Latches and D-Type Flip-Flops With Qualified Storage Enable
- Bus-Hold Data Inputs Eliminate the Need for External Pullup Resistors on A Port
- Flow-Through Architecture Optimizes PCB Layout
- Packaged in Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 17-bit registered bus transceiver combines D-type latches and D-type flip-flops to allow data flow in transparent, latched, and clocked modes. It provides for a copy of CLKAB at GTL logic levels (CLKOUT). It also provides a conversion of the GTL clock to a TTL environment (CLKIN).

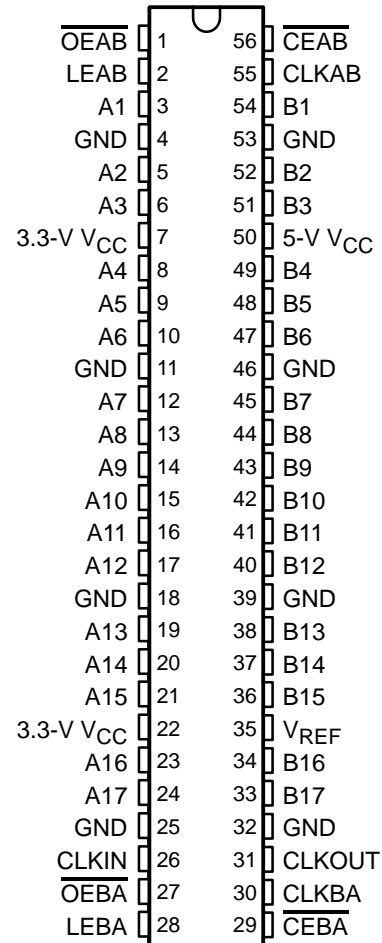
The B port operates at GTL levels while the A port and control pins are compatible with LVCMOS, LVTTL, or 5-V TTL logic levels.

Data flow in each direction is controlled by output-enable (\overline{OEAB} and \overline{OEBA}), latch-enable (LEAB and LEBA), and clock (CLKAB and CLKBA) inputs. The clock or latch-enable can be controlled by the chip-enable (\overline{CEAB} and \overline{CEBA}) inputs. For A-to-B data flow, the device operates in the transparent mode when LEAB is high. When LEAB is low, the A data is latched if \overline{CEAB} is low and CLKAB is held at a high or low logic level. If LEAB is low, the A-bus data is stored in the latch/flip-flop on the low-to-high transition of CLKAB if \overline{CEAB} is also low. Output-enable \overline{OEAB} is active-low. When \overline{OEAB} is low, the outputs are active. When \overline{OEAB} is high, the outputs are in the high-impedance state. Data flow for B to A is similar to that of A to B but uses \overline{OEBA} , LEBA, CLKBA, and \overline{CEBA} .

To ensure the high-impedance state during power-up or power-down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

The SN74GTL16615 is characterized for operation from 0°C to 70°C.

DGG OR DL PACKAGE
(TOP VIEW)



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FUNCTION TABLE†

INPUTS					OUTPUT B	MODE
CEAB	OEAB	LEAB	CLKAB	A		
X	H	X	X	X	Z	Latched storage of A data
L	L	L	H or L	X	B ₀ ‡	
L	L	L	H or L	X	B ₀ §	
X	L	H	X	L	L	Transparent
X	L	H	X	H	H	
L	L	L	↑	L	L	Clocked storage of A data
L	L	L	↑	H	H	
H	L	L	X	X	B ₀ §	Clock inhibit

† A-to-B data flow is shown: B-to-A data flow is similar but uses OEBA, LEBA, CLKBA, and CEBA.

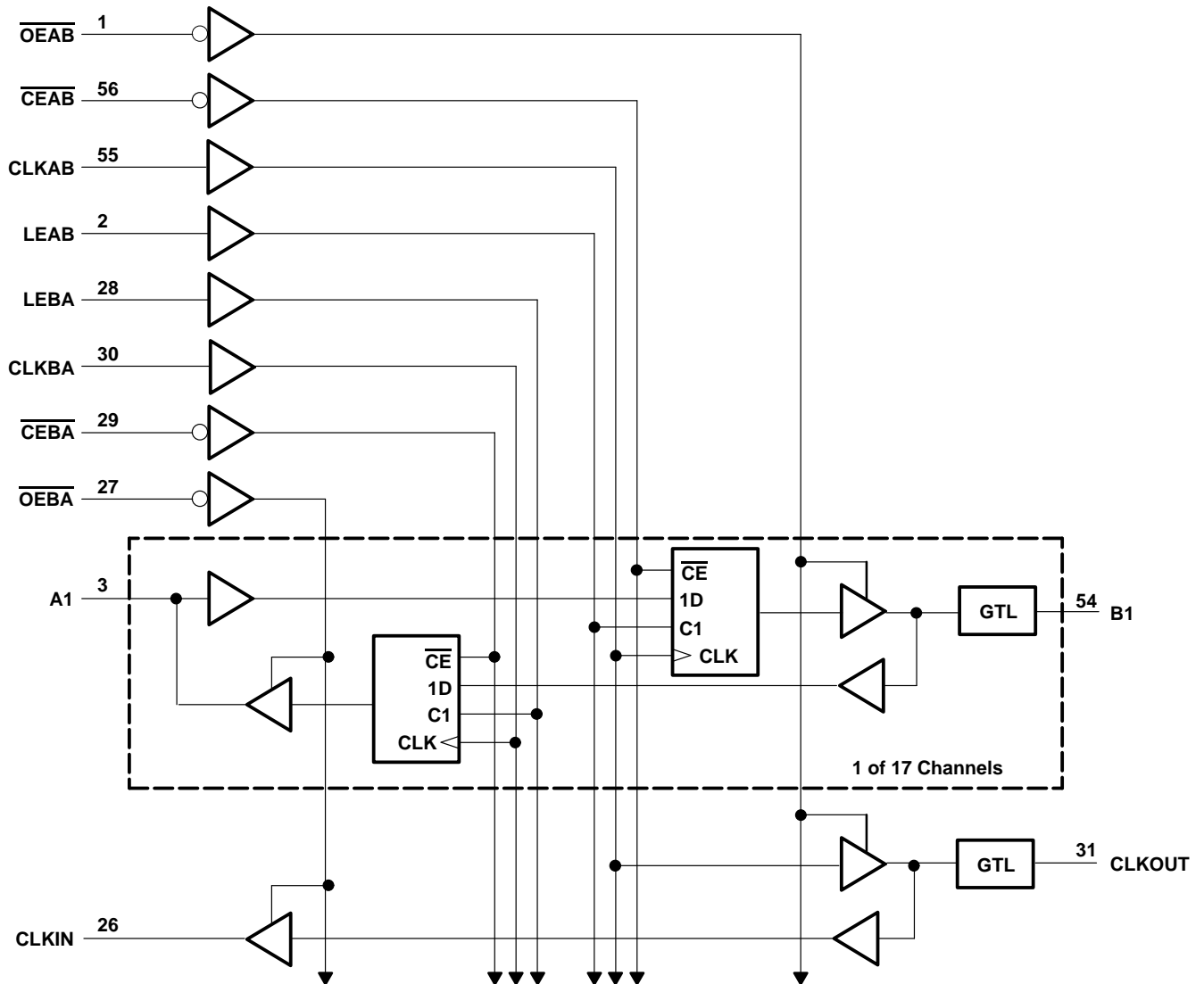
‡ Output level before the indicated steady-state input conditions were established, provided that CLKAB was high before LEAB went low.

§ Output level before the indicated steady-state input conditions were established.

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range, 3.3 V, V_{CC}	–0.5 V to 4.6 V
Supply voltage range, 5 V, V_{CC}	–0.5 V to 7 V
Input voltage range, V_I (see Note 1)	–0.5 V to 7 V
Voltage range applied to any output in the high state or power-off state, V_O (see Note 1)	–0.5 V to 7 V
Current into any A-port output in the low state, I_O	128 mA
Current into any B-port output in the low state, I_O	80 mA
Current into any A-port output in the high state, I_O (see Note 2)	64 mA
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air): DGG package	1 W
DL package	1.4 W
Storage temperature range	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This current will only flow when the output is in the high state and $V_O > V_{CC}$.

recommended operating conditions

			MIN	NOM	MAX	UNIT
V _{CC}	Supply voltage, 3.3 V		3.15	3.3	3.45	V
	Supply voltage, 5 V		4.75	5	5.25	
V _{REF}	Supply voltage		0.8			V
V _I	Input voltage	B port	V _{CC}			V
		Except B port	5.5			
V _{IH}	High-level input voltage	B port	V _{REF} + 50 mV			V
		Except B port	2			
V _{IL}	Low-level input voltage	B port	V _{REF} – 50 mV			V
		Except B port	0.8			
I _{IK}	Input clamp current		–18			mA
I _{OH}	High-level output current	A port	–32			mA
I _{OL}	Low-level output current	A port [‡]	64			mA
		B port	40			
T _A	Operating free-air temperature		0	70		°C

[‡] Current duty cycle $\leq 50\%$, $f \geq 1\text{ kHz}$

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electrical characteristics over recommended operating free-air temperature range, $V_{REF} = 0.8\text{ V}$ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP [†]	MAX	UNIT
V_{IK}		$V_{CC} = 3.15\text{ V}$, $I_I = -18\text{ mA}$				-1.2	V
V_{OH}	A port	$V_{CC} = \text{MIN to MAX}^\ddagger$, $I_{OH} = -100\text{ }\mu\text{A}$		$V_{CC} - 0.2$			V
		$V_{CC} = 3.15\text{ V}$	$I_{OH} = -8\text{ mA}$	2.4			
			$I_{OH} = -32\text{ mA}$	2			
V_{OL}	A port	$V_{CC} = 3.15\text{ V}$	$I_{OL} = 100\text{ }\mu\text{A}$			0.2	V
			$I_{OL} = 16\text{ mA}$			0.4	
			$I_{OL} = 32\text{ mA}$			0.5	
			$I_{OL} = 64\text{ mA}$			0.55	
	B port	$V_{CC} = 3.15\text{ V}$, $I_{OL} = 40\text{ mA}$				0.4	
I_I	Control pins	$V_{CC} = 0\text{ or MAX}^\ddagger$, $V_I = 5.5\text{ V}$				10	μA
	A port [§]	$V_{CC} = 3.45\text{ V}$	$V_I = 5.5\text{ V}$			20	μA
			$V_I = V_{CC}$			1	
			$V_I = 0$			-5	
	B port	$V_{CC} = 3.45\text{ V}$	$V_I = V_{CC}$ $V_I = 0$			5 -5	
I_{off}	A port	$V_{CC} = 0$	$V_I\text{ or }V_O = 0\text{ to }4.5\text{ V}$			100	μA
	B port		$V_I\text{ or }V_O = 0\text{ to }1.2\text{ V}$			100	
$I_I(\text{hold})$	A port	$V_{CC} = 3.15\text{ V}$	$V_I = 0.8\text{ V}$		75		μA
			$V_I = 2\text{ V}$		-75		
I_{OZH}	A port	$V_{CC} = 3.45\text{ V}$	$V_O = 3\text{ V}$			1	μA
	B port		$V_O = 1.2\text{ V}$			10	
	CLKIN		$V_O = 3\text{ V}$			5	
I_{OZL}	A port	$V_{CC} = 3.45\text{ V}$	$V_O = 0.5\text{ V}$			-1	μA
	B port		$V_O = 0.4\text{ V}$			-10	
	CLKIN		$V_O = 0.5\text{ V}$			-5	
I_{CC}	A port to B port	$V_{CC} = 3.45\text{ V}$, $V_I = V_{CC}\text{ or GND}$	$I_O = 0$,				mA
	B port to A port						
	Outputs disabled						
ΔI_{CC}^\parallel		$V_{CC} = 3.45\text{ V}$, A or control inputs at $V_{CC}\text{ or GND}$	One input at 2.7 V ,			1	mA
C_i	Control pins	$V_I = 3.15\text{ V or }0$			4		pF
C_{io}	A port	$V_O = 3.15\text{ V or }0$			10		pF
C_{io}	B port	Per IEEE1194.0-1991				5	pF

[†] All typical values are at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$.

[‡] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

[§] Unused pins at $V_{CC}\text{ or GND}$

[¶] This is the increase in supply current for each input that is at the specified TTL voltage level rather than $V_{CC}\text{ or GND}$.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature, $V_{REF} = 0.8\text{ V}$ (unless otherwise noted)

			MIN	MAX	UNIT
f_{clock}	Clock frequency		0	150	MHz
t_w	Pulse duration	LEAB or LEBA high			ns
		CLKAB or CLKBA high or low			
t_{su}	Setup time	A before CLKAB \uparrow	1.5		ns
		B before CLKAB \uparrow	3		
		A before LEAB \downarrow	0.5		
		B before LEBA \downarrow	1.5		
		\overline{CEAB} before CLKAB \uparrow			
		\overline{CEBA} before CLKBA \uparrow			
		\overline{CEAB} before LEAB \downarrow			
		\overline{CEBA} before LEBA \downarrow			
t_h	Hold time	A after CLKAB \uparrow	1		ns
		B after CLKAB \uparrow	0		
		A after LEAB \downarrow	2.5		
		B after LEBA \downarrow	2		
		\overline{CEAB} after CLKAB \uparrow			
		\overline{CEBA} after CLKBA \uparrow			
		\overline{CEAB} after LEAB \downarrow			
		\overline{CEBA} after LEBA \downarrow			

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